

INSTRUCTIONS FOR REPEATER CONTROL BOARDS 19D417385G1 & G2

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DESCRIPTION

The 19D417385G1 Repeater Control Board is used in MASTR® II repeater control applications without Channel Guard. The board consists of the transmit keying function, a drop-out delay timer and a 3-minute limit timer. The 19D417385G2 Repeater Control Board is used in repeater stations with Channel Guard. This board consists of the transmit keying function, a drop-out delay timer, a 3-minute limit timer and a Channel Guard control circuit.

CIRCUIT ANALYSIS

REPEATER CONTROL BOARD 19D417385G1

The Repeater Control Board receives its input from the station Receiver Unsquelled Sensor (RUS). When the receiver is unsquelled, the Receiver Unsquelled Sensor Operating Switch (RUSOS) lead is grounded at the Audio Board. This ground forward biases CR11 on the Repeater Control Board, turning on Q4. Conduction of Q4 operates the 3-minute limit timer.

The 3-minute limit timer is required by the FCC in certain applications to automatically shut off the transmitter after a maximum of three minutes continuous operation. The timer prevents the transmitter from accidentally "locking on" and tying up the channel.

Transistors Q1 and Q2 operate as an astable multi-vibrator, pulsing Q3 on and off. The pulsing of Q3

charges C3 in stairstep fashion until the charge applied to U1, terminal 6, is equal to 2/3 of the Vcc voltage applied to U1-8. U1 is a monolithic timing circuit with a comparator between the Vcc input (terminal 8) and the threshold input (terminal 6). When the compared voltage is equal to 2/3 of VCC, the flip-flop in U1 is operated, providing a high at the output (terminal 3). At the end of the timing period, determined by the setting of R8, a discharge path for C3 is provided at terminal 7 of U1.

The drop-out delay timer decreases the number of transmitter "ON-OFF" cycles by keeping the transmitter keyed for a predetermined delay period after the receiver squelches. The delay period can be set for 0.5 to 8 seconds. Unsqueling the receiver at any time during the delay period keeps the transmitter operating without interruption. After the delay time lapses, and no signal is applied to the receiver, the transmitter keying circuit is de-energized and the transmitter turns off.

When terminal 3 of U1 goes high, Q10 is turned on. Conduction of Q10 provides the threshold voltage to operate U2. This timer functions in the same manner as described for U1, with the timing period determined by the setting of R14. The high at terminal 3 of U1 forward biases CR2 and CR6, operating Q5. Conduction of Q5 applies ground through the REPEATER DISABLE ser-

vice switch S1 to the REPEATER PTT lead D3 to key the transmitter. The high at terminal 3 of U2 forward biases CR3 and CR6, also keying the transmitter. When a remote REPEATER DISABLE function is provided in the system, a ground is applied to terminal A4 on the Repeater Control Board when the function is selected. This ground is applied to the base of Q5, preventing the transistor from conducting and preventing the transmitter from being keyed.

REPEATER CONTROL BOARD 19D417385G2

The 19D417385G2 Repeater Control Board is required in repeater stations with Channel Guard. The CG DET OUTPUT lead (A3) on the Repeater Control Board is connected to the Channel Guard Board in the station receiver. When the Channel Guard is squelched, ground is applied to A3 and to the base of Q7. The transistor is held off, permitting Q8 to conduct. Conduction of Q8 applies ground to the RX 1 MUTE lead (A6) to keep the receiver squelched. If a signal modulated with the correct Channel Guard tone is received, Q7 is allowed to conduct. Conduction of Q7 turns Q8 off, removing the ground from A6 and unsquelching the receiver.

The RUS lead (D12) on the Repeater Control Board is at ground potential when the receiver is squelched. CR12 is forward biased, as well as CR8, preventing Q6 from conducting. The high at the collector of Q6 pre-

vents Q4 from conducting. When the receiver unsquelches, CR8 and CR12 are turned off. Q6 is turned on, allowing Q4 to conduct and operate the timing circuits.

When the Channel Guard modulated signal is no longer present, the CG DET OUTPUT lead (A3) goes low, forward biasing CR8 and turning off Q6. This eliminates the squelch tail. Q7 is also turned off, permitting Q8 to conduct and mute the receiver. The RUS lead (D12) now goes to ground, forward biasing CR12 to hold Q6 off.

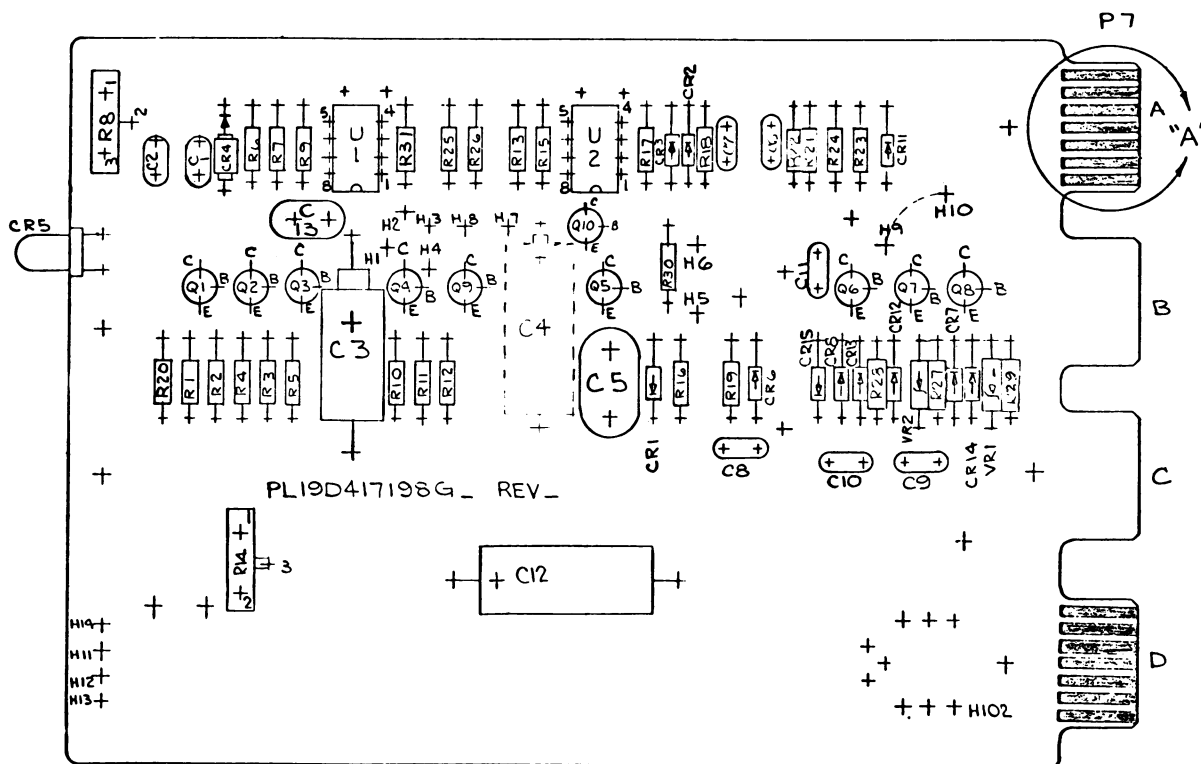
A ground applied to the CG MONITOR lead A7 will forward bias CR14 and turn Q8 off. This will allow the station receiver to operate only on noise squelch so that all transmissions will be monitored at the local or remote points. The repeater transmitter, however, will still be Channel Guard protected. This GC MONITOR ground may be originated at the MASTR Local Controller (in Local/Repeat Combinations) or at the Remote Control Board (in Remote/Repeat combinations).



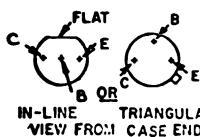
Ericsson GE Mobile Communications Inc.
Mountain View Road • Lynchburg, Virginia 24502

INSTRUCTIONS:

1. ADD JUMPER H9-H10 ON REPEATER CONTROL BOARD. (PL19D417385G1 OR 2) IF NOT INSTALLED.
2. ON THE REPEATER CONTROL BOARD: (PL19D417385G1) REMOVE C4 (100 UF).



LEAD IDENTIFICATION
FOR Q1-Q10



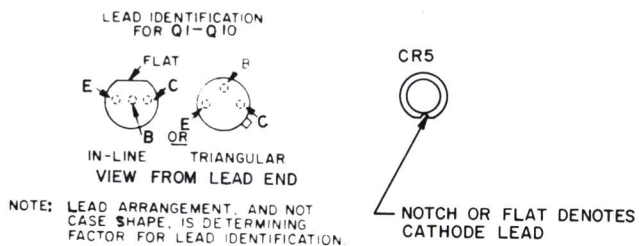
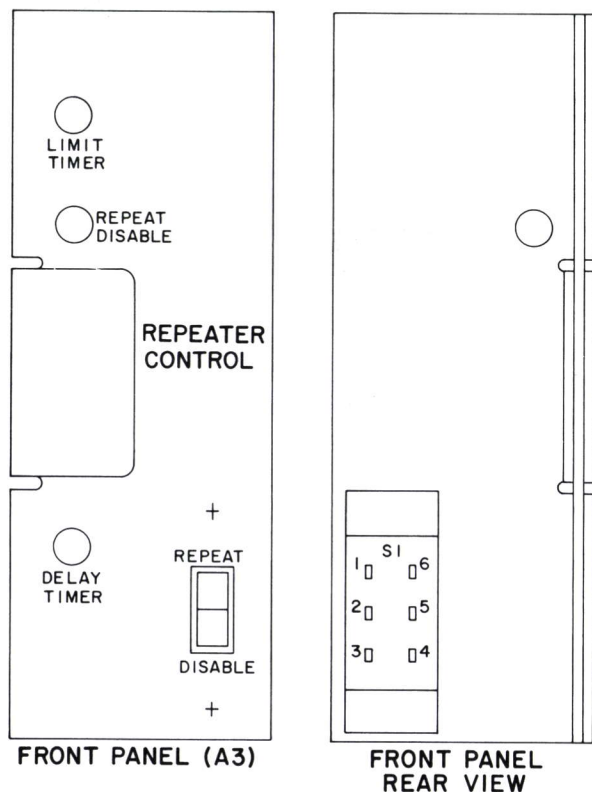
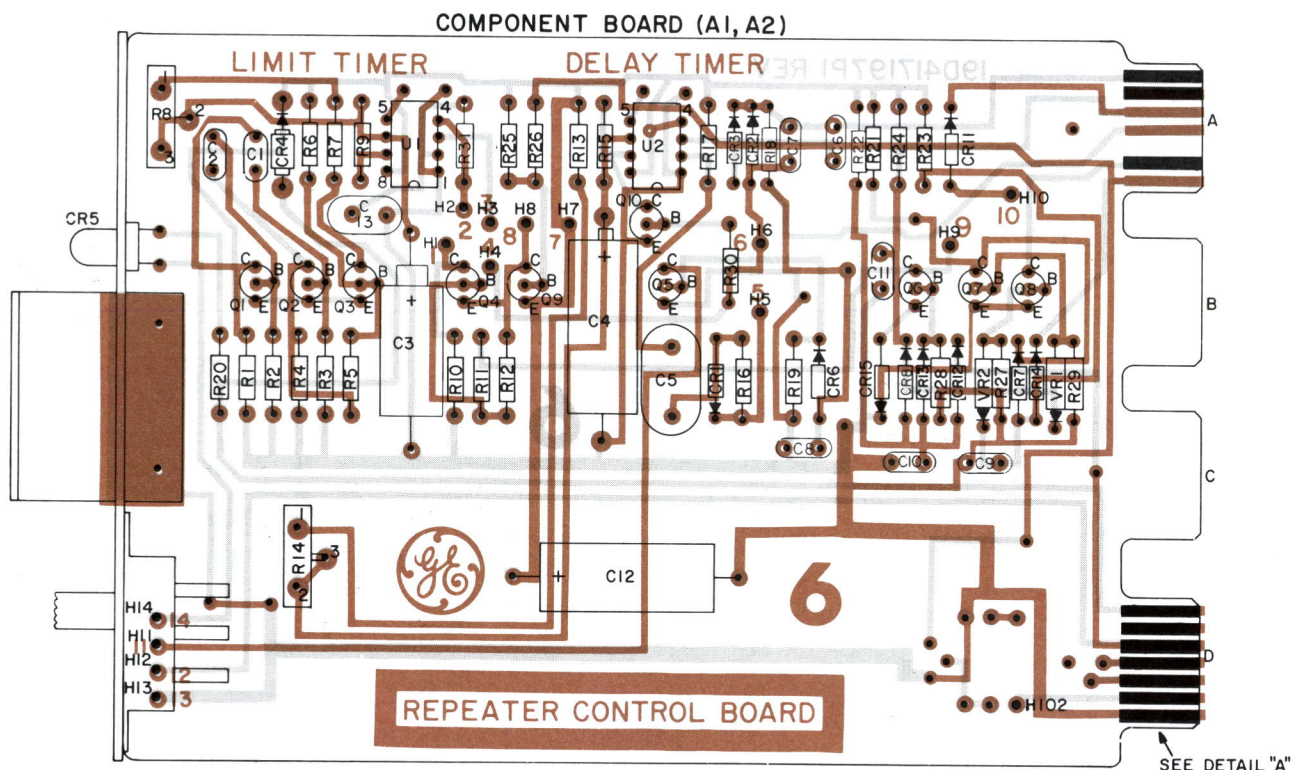
NOTE: LEAD ARRANGEMENT, AND NOT CASE SHAPE, IS DETERMINING FACTOR FOR LEAD IDENTIFICATION. TAB INDICATES EMITTER LEAD.



8 9 10 11 12 13 14
7 6 5 4 3 2 1
SOLDER SIDE
DETAIL "A"
TYP. NUMBERING OF COMPTON
FINGERS

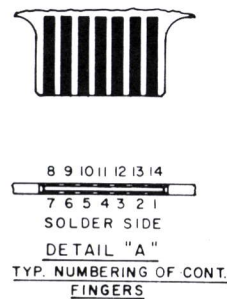
(19D433100, Rev. 1)

DATA MODIFICATION
MASTR II Station



SEE WIRING DIAGRAM FOR THE FOLLOWING CONNECTIONS

FROM	TO	GROUP
H1	H2	1 & 2
H3	H4	1 & 2
H5	H6	1 & 2
H7	H8	1 & 2
H9	H10	1



OUTLINE DIAGRAM

REPEATER CONTROL BOARD
19D417385G1 & G2

(19D423180, Rev. 6)
(19D417197, Sh. 2, Rev. 7)
(19D417197, Sh. 3, Rev. 7)

PARTS LIST			SYMBOL		
LBI4812D REPEATER CONTROL BOARD 19D417385G1, G2			GE PART NO.		
SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
A1 and A2		COMPONENT BOARD 19D417198G1, G2	R10	3R152P202J	Composition: 2K ohms ±5%, 1/4 w.
C1 and C2 C3 C4 C5 C6 thru C11 C12 C13 C14 and C15	T644ACP310K	----- CAPACITORS ----- Polyester: 0.010 uF ±10%, 50 VDCW.	R11	3R152P512J	Composition: 5.1K ohms ±5%, 1/4 w.
	19B200240P3	Tantalum: 150 uF ±20%, 15 VDCW.	R12	19A700106P63	Composition: 1K ohms ±5%, 1/4 w.
	19A115680P7	Electrolytic: 100 uF +150-10%, 15 VDCW; sim to Mallory Type TTX.	R13	19A700106P71	Composition: 2.2K ohms ±5%, 1/4 w.
	19A116080P109	Polyester: 0.22 uF ±10%, 50 VDCW.	R14	19B209358P109	Variable, carbon film: approx 3000 to 100,000 ohms ±20%, 1/4 w; sim to CTS Type U-201.
	19A700233P7	Ceramic: 1000 pF ±20%, 50 VDCW.	R15	19A700106P39	Composition: 100 ohms ±5%, 1/4 w.
	19A115680P7	Electrolytic: 100 uF +150-10%, 15 VDCW; sim to Mallory Type TTX.	R16	19A700106P111	Composition: 100K ohms ±5%, 1/4 w.
	T644ACP347K	Polyester: 0.047 uF ±10%, 50 VDCW.	R17	19A700106P97	Composition: 27K ohms ±10%, 1/4 w.
	19A116080P101	Polyester: 0.01 uF ±10%, 50 VDCW.	R18	19A700106P63	Composition: 1K ohms ±5%, 1/4 w.
		----- DIODES AND RECTIFIERS -----	R19	3R152P512K	Composition: 5.1K ohms ±10%, 1/4 w.
	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R20	19A700106P63	Composition: 1K ohms ±5%, 1/4 w.
	T324ADP1041	Rectifier, silicon; general purpose.	R21	19A700106P71	Composition: 2.2K ohms ±5%, 1/4 w.
	162B3011P0002	Diode, optoelectronic: red; sim to Hew. Packard 5082-4650.	R22	3R152P753J	Composition: 75K ohms ±5%, 1/4 w.
	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R23 and R24	19A700106P87	Composition: 10K ohms ±5%, 1/4 w.
	19A115250P1	Silicon, fast recovery, 225 mA, 50 PIV.	R25	19A700106P71	Composition: 2.2K ohms ±5%, 1/4 w.
CR1 thru CR3 CR4 CR5 CR6 thru CR8 CR11 thru CR15 P7 Q1 thru Q4 Q5 thru Q8 Q9 Q10		----- VOLTAGE REGULATORS -----	R26	3R152P512J	Composition: 5.1K ohms ±5%, 1/4 w.
		Zener: 500 mW, 4.4 v. nominal.	R27	19A700106P87	Composition: 10K ohms ±5%, 1/4 w.
		Zener: 500 mW, 2.3 v. nominal.	R28 and R29	3R152P513J	Composition: 51K ohms ±5%, 1/4 w.
		----- FRONT PANEL 19C320791G1 -----	R30	19A700106P79	Composition: 4.7K ohms ±5%, 1/4 w.
		----- SWITCHES -----	R31	19A700106P111	Composition: 100K ohms ±5%, 1/4 w.
		Slide: DPDT; sim. to Switchcraft 11A1639.	U1 and U2	19A116968P1	Linear, timer: DUAL IN-LINE 8 Pin Mini Dip Package; sim to Signetics SA555N.
		----- MISCELLANEOUS -----	VR1	4036887P4	
		Handle assembly.	VR2	4036887P1	
			A3		
			S1	19B209261P8	
R1 R2 R3 R4 R5 R6 R7 R8 R9	19B219690G1				
	19A700022P1	Silicon, PNP; sim to Type 2N3906.			
	19A700023P1	Silicon, NPN; sim to Type 2N3904.			
	19A700022F1	Silicon, PNP; sim to Type 2N3906.			
	19A700023P1	Silicon, NPN; sim to Type 2N3904.			
		----- RESISTORS -----			
	3R152P432J	Composition: 4.3K ohms ±5%, 1/4 w.			
	3R152P124J	Composition: 120K ohms ±5%, 1/4 w.			
	3R152P163J	Composition: 16K ohms ±5%, 1/4 w.			
	19A700106P63	Composition: 1K ohms ±5%, 1/4 w.			
	19A700106P111	Composition: 100K ohms ±5%, 1/4 w.			
	3R152P203J	Composition: 20K ohms ±5%, 1/4 w.			
	19A700106P99	Composition: 33K ohms ±5%, 1/4 w.			
	19B209358P110	Variable, carbon film: approx 7K to 250K ohms ±20%, 0.25w; sim to CTS Type X-201.			
	19A700106P39	Composition: 100 ohms ±5%, 1/4 w.			

*COMPONENTS ADDED, DELETED OR CHANGED BY PRODUCTION CHANGES

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter," which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A - Component Board 19D417198G1, G2
To stop the transients from resetting the timer. Added C13 & R31.

REV. B - Component Board 19D417198G2
To make sure the repeater keys only when the RUS and Chan. Gd. are present. Changed R22.

REV. B - 19D417198G1
REV. C - 19D417198G2
To prevent RF from making the 3 minute timer erratic. Added C14 and C15.

REV. C - 19D417198G1
REV. D - 19D417198G2
To stop timer from oscillating. Removed C14 and C15.